	Material Compositi © Copyright 2005. IPC, B international and Pan-Ame	Bannockburn, Illinoi	. All rights reserved u	inder both	This docume level parts, t	ent is a declaration	ration on enco	of the substanc mpasses all lov	es withi wer leve	the manufac materials for	turer listed i	tem. N	Note: if thacturer ha	ne item is an as as engineering	sembly with loveresponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						ials and Mfg Information				
Supplier Informat	tion															
Company name*			Company unique ID			Unique ID Authority					Respons	Response Date*				
onsemi											2024-05	2024-05-04				
Contact Name		Title - Co	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Steward	s	Product E	Product Enviro Compliance			NA					Produc	Product-Env-Stewards@onsemi.com				
Authorized Representa	ative*	Title - Re	Title - Representative			Phone - Representative*				Email -	Email - Representative*					
Product-Env-Steward	Product E	Product Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com						
Requester I	tem Number	Mfr Item Number	n Number Mfr Item Name			Effective Da	ate V	Version	Manufacturing Site			Weight*		UOM	Unit Type	
	1	FAN3121CMX-F085		Low-Side Gate Driver SO8		2024-05-04 TH2				80.792	2	mg	Each			
Janufacturing Pr	occess Information															
Terminal Pla	minal Plating / Grid Array Material		Terminal Base Alloy J-S		MSL Rating P		Peak Process Body Temperature		ture M	e Max Time at Peak Temper		ure	Number	of Reflow Cyc	les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)) (no CU Alloy	CU Alloy 3			260		C	30	30		ds	3			
Comments																
TTENTION: MSL 3	Rated item requires Bak	ke and Dry Pack (a	ter electrical test)													
or more information	regarding material comp	oosition please refe	r to page 3													

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.16	mg	Supplier	Silicon (Si)	7440-21-3		2.16	mg
Die Attach	1.144		Supplier	Silver (Ag)	7440-22-4		0.8466	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.2974	mg
Lead Frame	31.571		Supplier	Silver (Ag)	7440-22-4		0.007	mg
			Supplier	Zinc (Zn)	7440-66-6		0.039	mg
			Supplier	Palladium (Pd)	7440-05-3		0.015	mg
			В	Nickel (Ni)	7440-02-0		0.404	mg
			Supplier	Gold (Au)	7440-57-5		0.009	mg
			Supplier	Iron (Fe)	7439-89-6		0.732	mg
			Supplier	Copper (Cu)	7440-50-8		30.339	mg
			Supplier	Phosphorus (P)	7723-14-0		0.026	mg
Mold Compound-Black	45.29		Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.83	mg
			Supplier	Carbon Black (C)	1333-86-4		0.09	mg
			Supplier	Silica (SiO2)	14464-46-1		39.42	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.95	mg
Wire Bond - Au	0.627	mg	Supplier	Gold (Au)	7440-57-5		0.627	mg